

#### STLVDS050

#### High speed differential line drivers and receivers

#### Feature summary

- Meets or exceed the requirements of ansi eia/tia-644-1995 standard
- Signaling rates up to 400Mbit/s
- Bus terminal ESD exceeds 6kV
- Operates from a single 3.3V supply
- Low-voltage differential signaling with typical output voltage of 350mV and a 100Ω load
- Propagation delay times:

Driver: 2ns (typ) Receiver: 3ns (typ)

■ Power dissipation at 200MHz:

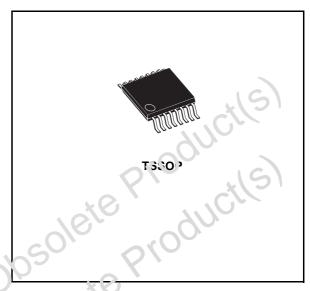
Driver: 25mW (typ) Receiver: 60mW (typ)

- LVTTL input levels are 5V tolerant
- Receiver has open-circuit fail-safe

#### **Description**

The STLVDS050 is differential line drivers and receivers that use low-vollage differential signaling (LVDS) to achieve signaling rate as high as 400Mbps.

The EIA/T. $^{\circ}$ -944 standard composint electrical interface provides a minimum differential output values magnitude of  $^{\circ}$ 4.7mV into a 100 $\Omega$  load and receipt of 100mV signals with up to 1V of ground potential difference between a transmitter and receives.



The intended application of this device an signaling recinique is for point-to-point baseband data transmission over controlled impedance the dia of approximately 100Ω characteristic impedance.

The transmission media may be printed-circuit board traces, backplanes, or cables. (Note: The ultimate rate and distance of data transfer is dependent upon the attenuation characteristics of the media, the noise coupling to the environment, and other application specific characteristics).

#### Order codes

Part number Temperature Range		Package	Comments	
STLVDS050BTR	-40 to 85 °C	TSSOP16 (Tape & Reel)	2500 parts per reel	

March 2006 Rev. 4 1/15

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STLVDS050 Pin configuration

# 1 Pin configuration

Figure 1. Pin connections and functional diagram

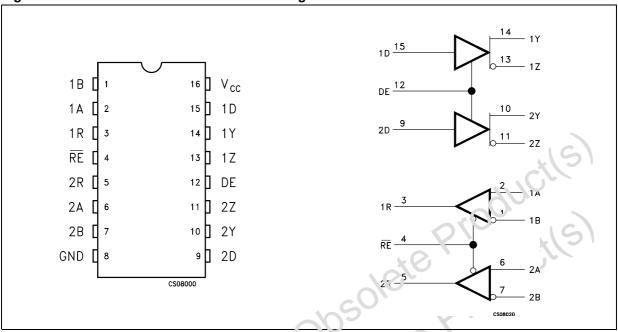


Table 1. Pin description

Pin n°	S <sub>j</sub> ·moc l	Name and function
1,2, 6, 7	, A. 1B, 2A, 2B	Receiver inputs
3, 5	1R, 2R	Receiver outputs
4	RE	Receiver enable
9, 15	2D, 1D	Driver inputs
12	DE	Driver enable
10, 11, 13, 14	2Y, 2Z, 1Y, 1Z	Driver outputs
8 K	GND	Ground
16	V <sub>CC</sub>	Supply voltage

Table 2. Truth table for receiver

$V_{ID} = V_A - V_B$	RE	R
V <sub>ID</sub> ≥ 100mV	L	Н
-100mV < V <sub>ID</sub> < 100mV	L	?
$V_{ID} \le -100 mV$	L	L
OPEN	L	Н
X	Н	Z

Pin configuration STLVDS050

Table 3. Truth table for driver

D	DE	Y	Z
L	Н	L	Н
Н	Н	Н	L
OPEN	Н	L	Н
X	L	Z	Z

L=Low level, H=High Level, X=Don't care, Z= High Impedance

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STLVDS050 Maximum ratings

# 2 Maximum ratings

Table 4. Absolute maximum ratings

Symbol	Parameter		Value	Unit
V <sub>CC</sub>	Supply voltage		-0.5 to 4	V
VI	Voltage range	D, R, DE, RE	-0.5 to 6	V
ESD	ESD Protection voltage (HPM)	Y, Z, A, B, and GND	± 6	kV
ESD	ESD Protection voltage (HBM)	All Pins	± 3	KV
T <sub>STG</sub>	Storage temperature range	·	-65 to 150	°C

Note:

Absolute Maximum Ratings are those values beyond which damage to the new ce may occur. Functional operation under these condition is not implied.

Table 5. Recommended operating conditions

V <sub>CC</sub>	Parameter	Min.	Тур.	Max.	Unit
	Supply voltage	3.0	3.3	3.6	V
V <sub>IH</sub>	HIGH level input voltage	2.0	010		V
V <sub>IL</sub>	LOW level input voltage			0.8	V
V <sub>ID</sub>	Magnitude of differential input voltage	0.1		0.6	V
V <sub>IC</sub>	Common mode input voltage	V <sub>ID</sub>  /2		24- V <sub>ID</sub>  /2	V
	Common mode input voitage	9		V <sub>CC</sub> -0.8	V
T <sub>A</sub>	Operating tempers ture cange	-40		85	°C
5019	ete Product(s)				

Electrical characteristics STLVDS050

## 3 Electrical characteristics

Table 6. Electrical characteristics (Typical values are at  $T_A = 25$ °C,  $V_{CC} = 3.3V \pm 10\%$ ,  $T_A = -40$  to 85°C unless otherwise

Symbol	Parameter	Test	Min.	Тур.	Max.	Unit	
lcc	Supply Current	Drivers and receivers enabled, no receiver loads, driver $R_L$ =100 $\Omega$		12	20		
		Driver enabled, receivers disabled, $R_L$ =100 $\Omega$	d, receivers disabled,		16	mA	
		Drivers disabled, receiver enabled, no load		4	16		
		Disabled		C.5	<b>D</b> <sub>1</sub>		

Table 7. Driver electrical characteristics (Typical values are at  $T_A = 25^{\circ}\text{C}$ ,  $V_{CC} = 3.3\text{V} \pm 10\%$ ,  $T_{A} = -40$  to 85°C unless otherwise specified).

specilied).					$\Delta M$		
Symbol	Parameter	Test		Min.	Тур.	Max.	Unit
V <sub>OD</sub>	Differential output voltage magnitude	$R_L = 100\Omega$	.0.	247	340	454	mV
Δ V <sub>OD</sub>	Change in differential output voltage magnitude between logic states	P <sub>L</sub> = 100Ω		-50		50	mV
$\Delta V_{OC(SS)}$	Change in steady-state common mode output voltage between logic states	000		-50		50	mV
V <sub>OC(SS)</sub>	Steady-scate common mode output voltage	5)		1.125	1.2	1.375	V
V <sub>OC(PP)</sub>	Poak เอ peak common mode เมรุ่มut voltage				50	150	mV
5	High lovel input surrent	V - <b>5</b> V	DE		-0.5	-20	μΑ
Ή	High level input current	V <sub>IH</sub> = 5V	D		2	20	μΑ
	Loui loval input aurrant	V 0.0V	DE		-0.5	-10	μΑ
I <sub>IL</sub>	Low level input current	$V_{IL} = 0.8V$	D		1	10	μΑ
02	Chart aircuit autaut aurrant	$V_{O(Y)}$ or $V_{O(Z)} = 0V$			6	10	mA
los	Short circuit output current	V <sub>OD</sub> = 0			4	10	mA
	High impedance output augreent	V <sub>O</sub> = 600mV				± 1	μΑ
l <sub>OZ</sub>	High impedance output current	$V_O = 0V \text{ or } V_{CC}$				± 1	μΑ
I <sub>O(OFF)</sub>	Power OFF output current	$V_{CC} = 0VV_O = 3.6V$				± 1	μΑ
C <sub>IN</sub>	Input capacitance				3		pF

Table 8. Receiver electrical characteristics (Typical values are at  $T_A = 25$ °C,  $V_{CC} = 3.3$ V ±10%,  $T_A = -40$  to 85°C unless otherwise specified).

Symbol	Parameter	Test	Min.	Тур.	Max.	Unit
V <sub>ITH+</sub>	Positive-going differential input voltage threshold				100	mV
V <sub>ITH-</sub>	Negative-going differential input voltage threshold		-100			mV
V <sub>OH</sub>	High level output voltage	I <sub>OH</sub> = -8mA	2.4			V
V <sub>OL</sub>	Low level output voltage	I <sub>OL</sub> = 2mA			0.4	V
	Input ourront (A or P Inputs)	V <sub>I</sub> =0V	-2	-11	-20	μA
l <sub>l</sub>	Input current (A or B Inputs)	V <sub>I</sub> = 2.4V	-1	-3		μΑ
I <sub>I(OFF)</sub>	Power OFF input current (A or B Inputs)	V <sub>CC</sub> = 0V	0.5	OQIO	±20	μΑ
I <sub>IH</sub>	High level input current (Enable)	V <sub>IH</sub> = 5V			±10	μΑ
I <sub>IL</sub>	Low level input current (Enable)	V <sub>IL</sub> = 0.8V		\	±10	μΑ
I <sub>OZ</sub>	High impedance output current	V <sub>O</sub> = 0 or 5V		00,0	± 10	μΑ
C <sub>IN</sub>	Input capacitance	100	01	3		pF

Table 9. Driver switching characteristics (Typical values are at  $T_A = 25$ °C,  $V_{CC} = 3.3V \pm 10\%$ ,  $T_A = -40$  to 85°C unless otherwise specified).

Symbol	Parameter	Test	Min.	Тур.	Max.	Unit
t <sub>PLH</sub>	Propagation dolay time, low to high output			2	2.7	ns
t <sub>PHL</sub>	Propagation delay time, high to low	$R_L = 100\Omega$ $C_L = 10pF$		2	2.7	ns
t <sub>r</sub>	Differential output signal rise time			0.4	1	ns
CH	Differential output signal fall time			0.4	1	ns
t <sub>sk(P)</sub>	Pulse skew ( t <sub>THL</sub> - t <sub>TLH</sub>  ) <sup>(1)</sup>			50		ps
t <sub>sk(O)</sub>	Channel-to-channel output skew (2)			40		ps
t <sub>PZH</sub>	Propagation delay time, high impedance to high level output			6	10	ns
t <sub>PZL</sub>	Propagation delay time, high impedance to low level output			6	10	ns
t <sub>PHZ</sub>	Propagation delay time, high level to high impedance output			3	10	ns
t <sub>PLZ</sub>	Propagation delay time, low level to high impedance output			3	10	ns

<sup>1.</sup>  $t_{sk(P)}$  is the magnitude of the time difference between the high to low and low to high propagation delay times at an output

<sup>2.</sup>  $t_{sk(O)}$  is the magnitude of the time difference between the output of a single device with all their inputs connected together

**Electrical characteristics** STLVDS050

Receiver switching characteristics Table 10.

(Typical values are at  $T_A$  = 25°C,  $V_{CC}$  = 3.3V ±10%,  $T_A$  = -40 to 85°C unless otherwise specified).

Symbol	Parameter	Test	Min.	Тур.	Max.	Unit
t <sub>PLH</sub>	Propagation delay time, low to high output			3.0	4.0	ns
t <sub>PHL</sub>	Propagation delay time, high to low output	C <sub>1</sub> = 10pF		3.0	4.0	ns
t <sub>r</sub>	Differential output signal rise time			0.6	1	ns
t <sub>f</sub>	Differential output signal fall time			0.6	1	ns
t <sub>sk(P)</sub>	Pulse skew ( t <sub>THL</sub> - t <sub>TLH</sub>  ) (Note 1)			0.25	110	rs
t <sub>PZH</sub>	Propagation delay time, high impedance to high level output			2.5	Cri	ns
t <sub>PZL</sub>	Propagation delay time, high impedance to low level output		01	2.5	.10	ns
t <sub>PHZ</sub>	Propagation delay time, high level to high impedance output	18,6		7		ns
t <sub>PLZ</sub>	Propagation delay time, low level to high impedance output	125010	01	4		ns

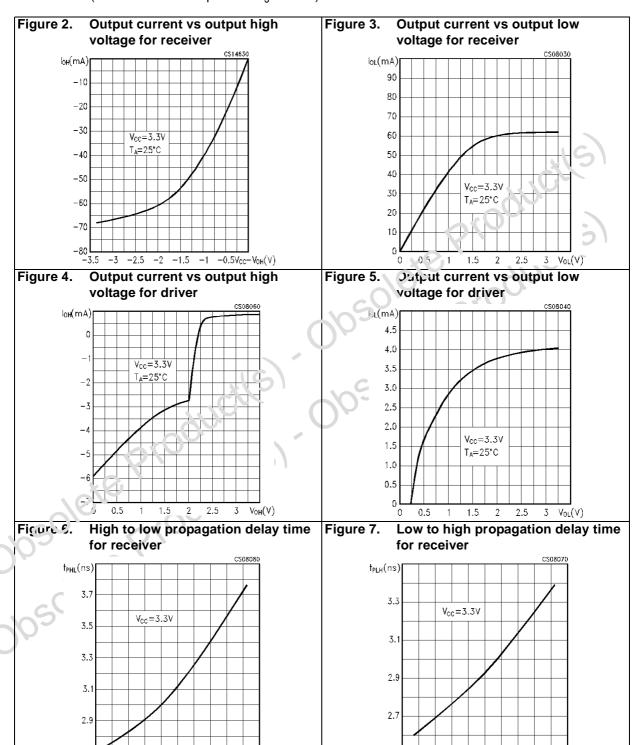
Note 1: t<sub>sk(P)</sub> is the magnitude of the time difference between the high to low and low to high propagation delay times at an output

Note 2:  $t_{sk(O)}$  is the magnitude of the time difference between the output of a single device with all their inputs connected together.

gnitude of the with the same sup Note 3:  $t_{sk(PP)}$  is the magnitude of the difference between any specified terminals of two devices when both devices operate with the same supply voltages, same temperature, and have identical packages and test

# 4 Typical performance characteristics

(Unless otherwise specified  $T_J = 25$ °C)



2.5

-20

60

100

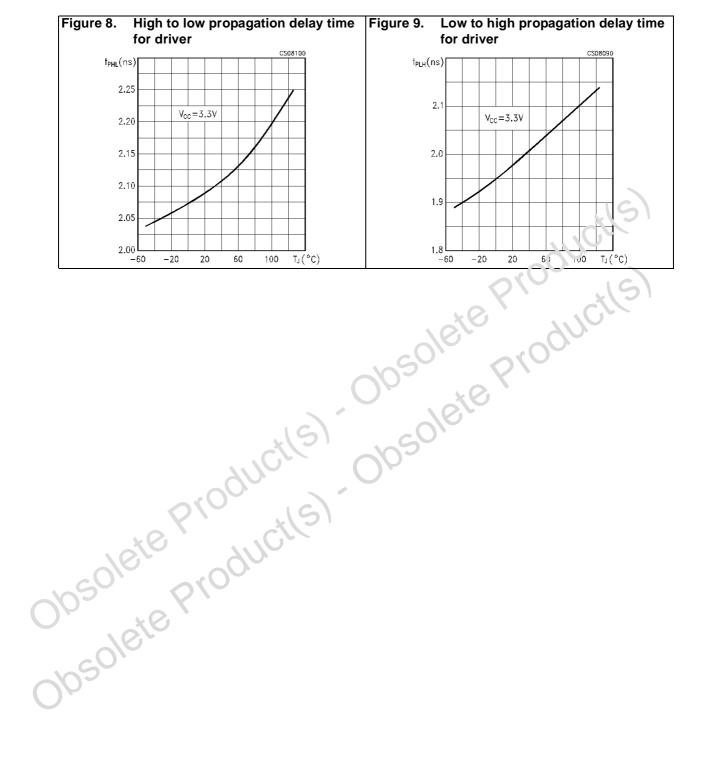
577

2.7

20

TJ(°C)

 $T_J(\,{}^{\circ}C)$ 



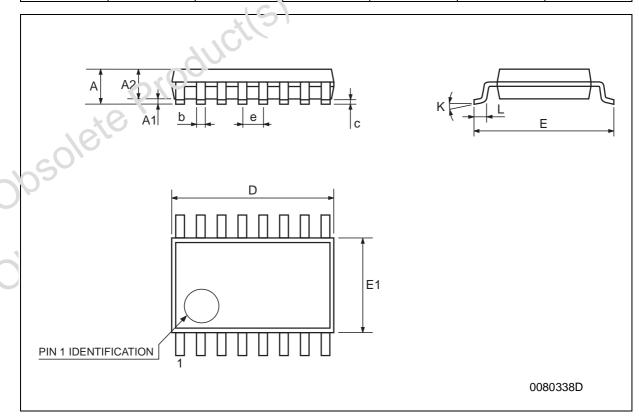
## 5 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK<sup>®</sup> packages. These packages have a Lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

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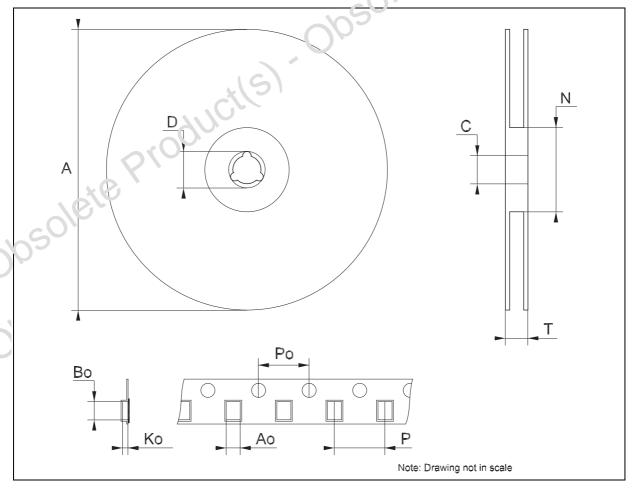
## **TSSOP16 MECHANICAL DATA**

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
А			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
С	0.09		0.20	0.004		0.2079
D	4.9	5	5.1	0.193	0.197	0.201
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.109	0.173	0.176
е		0.65 BSC		0/0	0.0256 BSC	
K	0°		S. O	0°		8°
L	0.45	0.60	0.15	0.018	0.024	0.030



# Tape & Reel TSSOP16 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
А			330			12.992
С	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
Т			22.4			C 202
Ao	6.7		6.9	0.264		0.272
Во	5.3		5.5	0.209	00/0	0.217
Ko	1.6		1.8	0.063	210	0.071
Ро	3.9		4.1	0.153		0.161
Р	7.9		8.1	(1.311		0.319



Revision history STLVDS050

## 6 Revision history

Table 11. Revision history

Date	Revision	Changes
22-Mar-2006	4	Order codes has been updated and new template.

Obsolete Products). Obsolete Products) Obsolete Products) Obsolete Products).

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